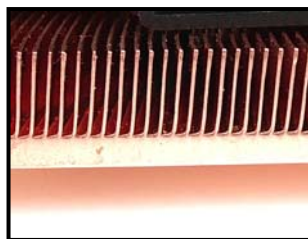




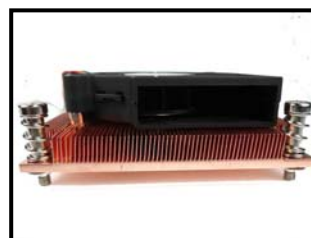
*The Aesthetics of heat dispersion*



**All copper, Skive Fin Technology**



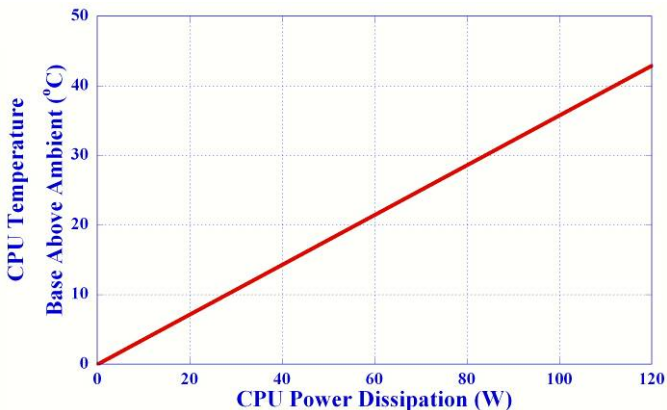
**Top View**



**Side View**

### Product Specification

<b>Application Socket</b>	Intel LGA 2011
<b>Heat Sink Dimension</b>	90mm X 90mm X 12mm
<b>Heat Sink Material</b>	Copper
<b>Fan Dimension</b>	Φ75 X 15
<b>Bearing Type</b>	2Ball Bearing Fan Life Expectancy at 40°C 50000HR
<b>Fan Speed (RPM)</b>	1000±400rpm~5500±10%
<b>Fan Airflow (CFM)</b>	11.83 Max
<b>Static Pressure (mm H2O)</b>	20.66 Max
<b>Fan Noise Level (dBA)</b>	<56
<b>Rated Voltage (V)</b>	12
<b>Weight (g)</b>	400



### Features:

- All Copper Provides Faster Heat Dissipation Rate
- Design For 1U Server
- PWM Function Fan for a Silent Operation
- Max Power Dissipation 95W

Unit : mm

